#### **Irradiated ROCs 1**

Daniel Pitzl, DESY
Hamburg CMS Pixel Upgrade meeting, 30.11.2012

- LHC dose vs radius
- Analog current vs Vana DAC
- Measured on the test board
- Digital ROCs:
  - unirradiated
  - irradiated

#### **Tracker radiation dose**

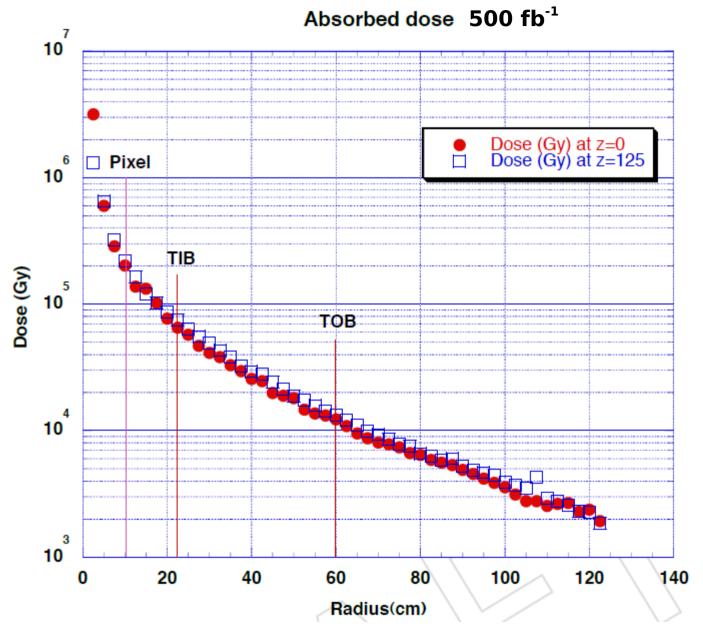
Layer 1: 1 MGy

**Layer 2: 400 kGy** 

**Layer 3: 200 kGy** 

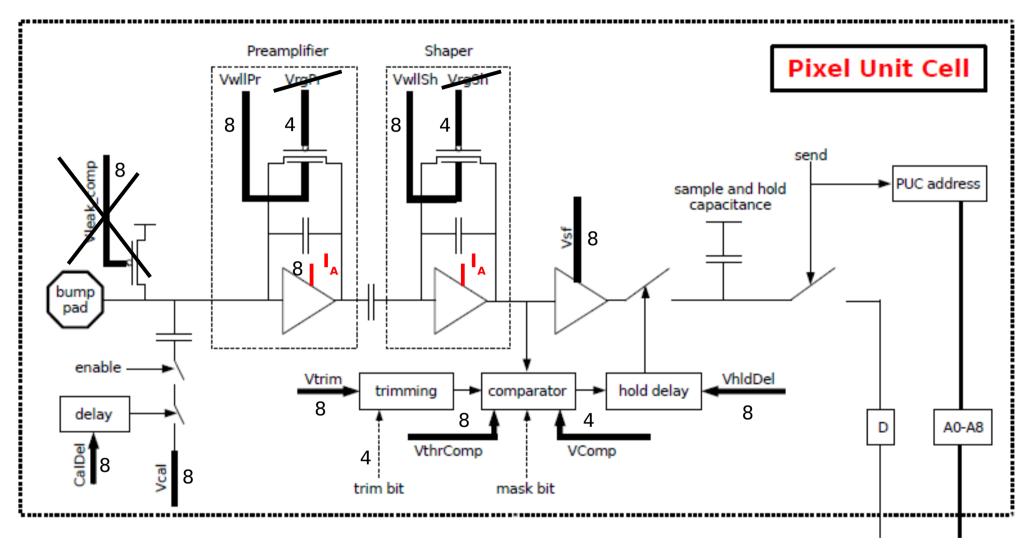
**Layer 4: 150 kGy** 

100 kGy = 10 Mrad



Pixel upgrade TDR 2012

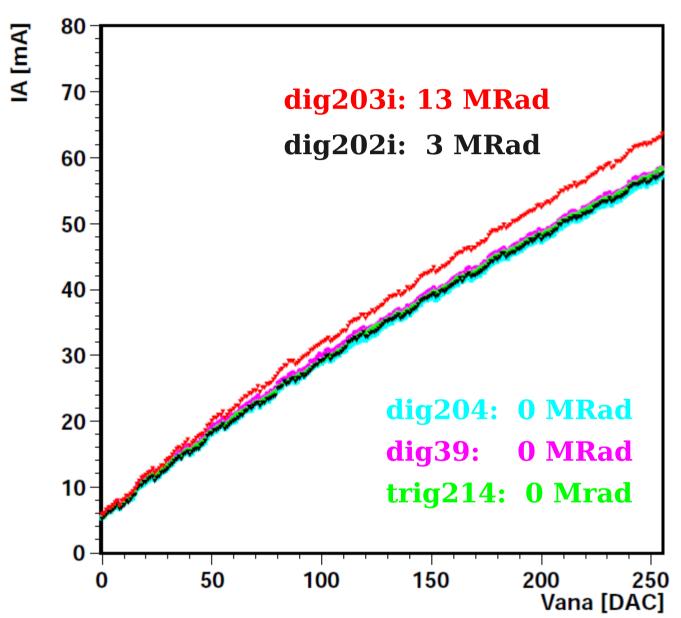
# psi46dig pixel unit cell



adjustable by programmable DAC

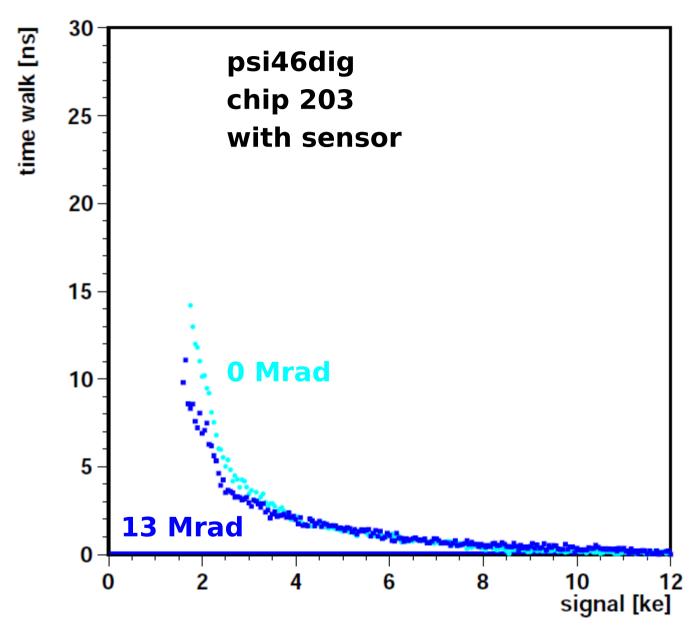
supplied by analog current

## **Analog current vs Vana DAC**



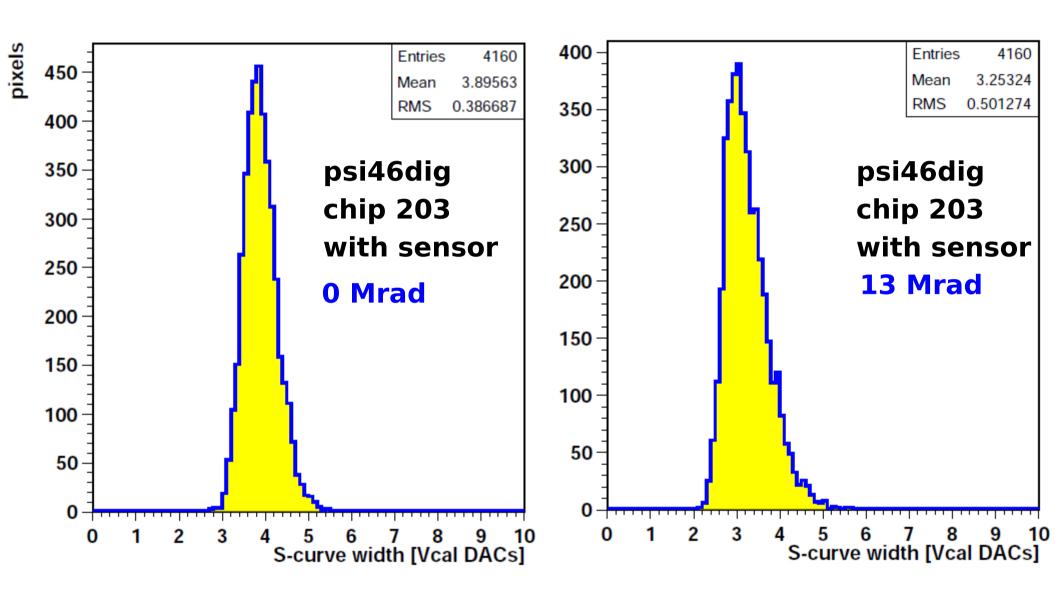
- Test board:
  - ▶ va 1900 mV
- Vana: 8 bit DAC, scanned in steps of one, with 500 ms delay.
- Current measured on the test board: GetIA
- 3 unirradiated ROCs are similar
- no change after 3 MRad.
- 10% higher with 13 MRad.

### **Timewalk**



- Chip 203
  - with sensor
  - ▶ Ia 35 mA
  - trimmed to 1.5 ke threshold (Vcal 30)
  - pixel 22 22
  - before and after 13 Mrad

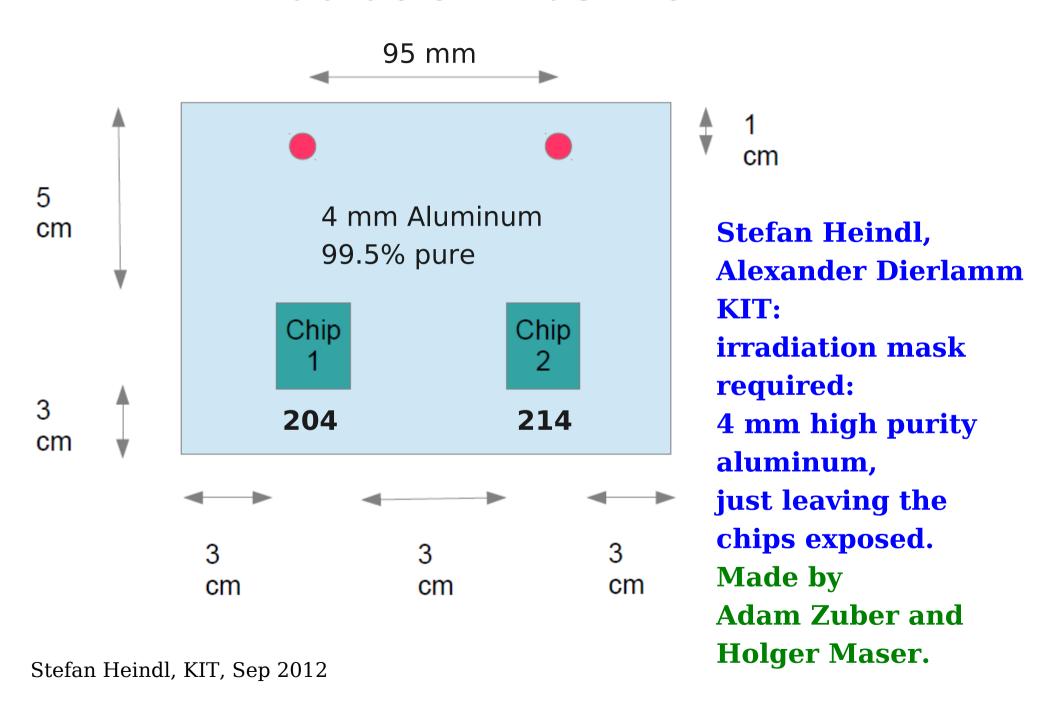
### **Noise**



# **Chip 203**

- with sensor
- Ia 35 mA
- trimmed to 1.5 ke threshold (Vcal 30)
- pixel 22 22
- before and after 13 Mrad

### irradiation mask for KIT



## **Summary**

- psi46dig ROCs with sensor irradiated at CERN to 3 and 13 Mrad
  - fully functional
  - 10% analog current increase after 13 Mrad
  - noise, time walk not worse
- Next:
  - transport back to DESY
  - more lab tests
  - beam test in January
  - X-ray test at Uni
- Further irradiation:
  - psi46dig ROCs 204 and 214 without sensors fully characterized
  - send to KIT Zyklotron lab
  - ▶ irradiated to 30 and 100 Mrad in Jan '13

# Back up

### psi46 test board



Single chip module:

- Indium bump bonded at PSI
- Glued and wire bonded to carrier printed circuit board
- ► Interface card to psi46 TB with edge connector
- ETH adapter card for digital 160 MHz differential signal directly into FPGA (LCDS into LVDS)

64 MB memory